TEXAS INSTRUMENTS

SN74AXC1T45

SCES882 – DECEMBER 2017

SN74AXC1T45 Single-Bit Dual-Supply Bus Transceiver With Configurable Voltage Translation and Tri-State Outputs

1 Features

- Up and Down Translation Across 0.65 V to 3.6 V
- Operating Temperature: –40°C to +125°C
- Glitch Free Power Supply Sequencing
- Maximum Quiescent Current (I_{CCA} + I_{CCB}) of 6 µA (85°C Maximum) and 14 µA (125°C Maximum)
- 500-Mbps Support When Both V_{CCA} and V_{CCB} Are at Least 1.65 V
- V_{CC} Isolation Feature
  - If Either V_{CC} Input is Below 100 mV, All I/Os Outputs are Disabled and Become High-Impedance
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
  - 8000-V Human Body Model
  - 1000-V Charged-Device Model

2 Applications

- Enterprise and Communications
- Industrial
- Personal Electronics

3 Description

The SN74AXC1T45 is a single-bit noninverting bus transceiver that uses two separate configurable power-supply rails. The device is operational with both V_{CCA} and V_{CCB} supplies as low as 0.65 V. The A port is designed to track V_{CCA}, which accepts any supply voltage from 0.65 V to 3.6 V. The B port is designed to track V_{CCB}, which also accepts any supply voltage from 0.65 V to 3.6 V.

The DIR pin determines the direction of signal propagation. With the DIR pin configured HIGH, translation is from Port A to Port B. With DIR configured LOW, translation is from Port B to Port A. The DIR pin is referenced to V_{CCA}, meaning that its logic-high and logic-low thresholds track with V_{CCA}.

This device is fully specified for partial-power-down applications using the I_{off} current. The I_{off} protection circuitry ensures that no excessive current is drawn from or to an input, output, or combined I/O that is biased to a specific voltage while the device is powered down.

The V_{CC} isolation feature ensures that if either V_{CCA} or V_{CCB} is less than 100 mV, both I/O ports enter a high-impedance state by disabling their outputs.
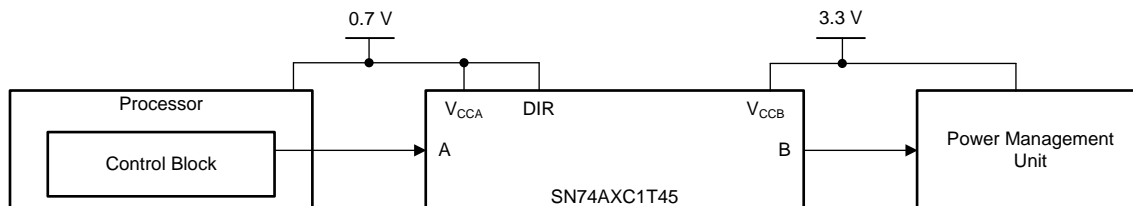
Glitch-free supply sequencing permits either supply rail to be powered on or off, in any order, without producing a data glitch (that is an output waveform that momentarily transitions from Logic Low to Logic High).

Device Information[1]

PART NUMBER	PACKAGE	BODY SIZE (NOM)
SN74AXC1T45DBV	SOT-23 (6)	2.90 mm × 1.60 mm
SN74AXC1T45DCK	SC70 (6)	2.00 mm × 1.25 mm
SN74AXC1T45DRL	SOT-5X3 (6)	1.60 mm × 1.20 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Example Application

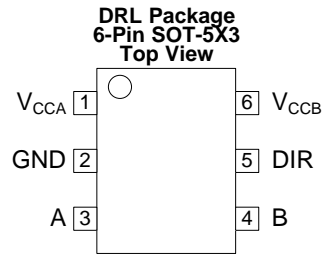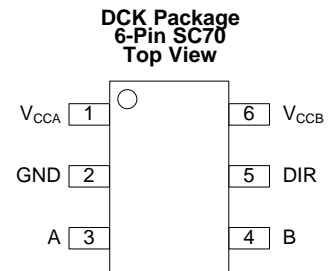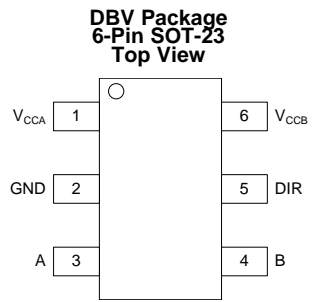Copyright © 2017, Texas Instruments Incorporated

---

Table of Contents

4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
December 2017	*	Initial Release.

5 Pin Configuration and Functions

DBV Package
6-Pin SOT-23
Top View

V_{CCA}	1	6	V_{CCB}
GND	2	5	DIR
A	3	4	B

DCK Package
6-Pin SC70
Top View

V_{CCA}	1	6	V_{CCB}
GND	2	5	DIR
A	3	4	B

DRL Package
6-Pin SOT-5X3
Top View

V_{CCA}	1	6	V_{CCB}
GND	2	5	DIR
A	3	4	B

Product Folder Links: *SN74AXC1T45*

Pin Functions

PIN		TYPE	DESCRIPTION
NO.	NAME		
1	V_{CCA}	—	A-port supply voltage. 0.65V ≤ V_{CCA} ≤ 3.6 V
2	GND	—	Ground
3	A	I/O	Input/output A. This pin is referenced to V_{CCA}. When this pin is configured as an input, do not leave it floating.
4	B	I/O	Input/output B. This pin is referenced to V_{CCB}. When this pin is configured as an input, do not leave it floating.
5	DIR	I	Direction control signal. Set to Logic High for A-to-B level translation. Set to Logic Low for B-to-A level translation.
6	V_{CCB}	—	B-port supply voltage. 0.65V ≤ V_{CCB} ≤ 3.6 V.

Product Folder Links: *SN74AXC1T45*

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)[1]

			MIN	MAX	UNIT
V_{CCA}	Supply voltage, V_{CCA}		–0.5	4.2	V
V_{CCB}	Supply voltage, V_{CCB}		–0.5	4.2	V
V_I	Input voltage[2]	I/O ports (A port)	–0.5	4.2	V
		I/O ports (B port)	–0.5	4.2	
		DIR	–0.5	4.2	
V_O	Voltage applied to any output in the high-impedance or power-off state[2]	A port	–0.5	4.2	V
		B port	–0.5	4.2	
V_O	Voltage applied to any output in the high or low state[2][3]	A port	–0.5	V_{CCA} + 0.2	V
		B port	–0.5	V_{CCB} + 0.2	
I_{IK}	Input clamp current	$V_I < 0$		–50	mA
I_{OK}	Output clamp current	$V_O < 0$		–50	mA
I_O	Continuous output current		–50	50	mA
	Continuous current through V_{CCA}, V_{CCB}, or GND		–100	100	mA
T_J	Operating junction temperature			150	°C
T_{stg}	Storage temperature		–65	150	°C

(1) Stresses beyond those listed under the *Absolute Maximum Ratings* table may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The output positive-voltage rating may be exceeded up to 4.2 V maximum if the output current ratings are observed.

6.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001[1]	±8000	V
		Charged-device model (CDM), per JEDEC specification JESD22-C101[2]	±1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CCA}	Supply voltage, V_{CCA}		0.65	3.6	V
V_{CCB}	Supply voltage, V_{CCB}		0.65	3.6	V
V_I	Input voltage [1][2]		0	3.6	V
V_O	Output voltage	Active state	0	V_{CCO}[2]	V
		Tri-state	0	3.6	
$\Delta t/\Delta v$	Input transition rise or fall rate			100	ns/V
T_A	Operating free-air temperature		−40	125	°C

(1) All unused data inputs of the device must be held at V_{CCI} or GND to assure proper device operation. For more information, refer to the *Implications of Slow or Floating CMOS Inputs* application report.
(2) V_{CCI} is the V_{CC} with the input port. V_{CCO} is the V_{CC} associated with the output port.

6.4 Thermal Information

	THERMAL METRIC[1]	SN74AXC1T45			UNIT
		DBV (SOT-23)	DCK (SC70)	DRL (SOT-5X3)	
		6 PINS	6 PINS	6 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	202.2	235.3	298.9	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	137.2	160.5	148.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	80.2	76.9	165.0	°C/W
ψ_{JT}	Junction-to-top characterization parameter	64.0	59.7	20.7	°C/W
ψ_{JB}	Junction-to-board characterization parameter	80.4	77.1	164.9	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	N/A	N/A	N/A	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

6.5 Electrical Characteristics: –40°C ≤ T_A ≤ +85°C

over recommended operating free-air temperature range (unless otherwise noted)[1]

PARAMETER		TEST CONDITIONS[2][3]	MIN	MAX	UNIT
V_{IH}	High-level input voltage	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.70		V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.70		
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.65		
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V	1.6		
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V	2		
V_{IL}	Low-level input voltage	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} × 0.30	V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} × 0.30	
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} × 0.35	
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V		0.7	
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V		0.8	
V_{IH}	High-level input voltage DIR	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.70		V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.70		
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.65		
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V	1.6		
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V	2		
V_{IL}	Low-level input voltage DIR	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} × 0.30	V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} × 0.30	
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} × 0.35	
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V		0.7	
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V		0.8	
V_{OH}	High-level output voltage	V_I = V_{IH}, I_{OH} = –100 µA, V_{CCA} = V_{CCB} V_{CCI} = 0.7 V – 3.6 V, V_{CCO} = 0.7 V – 3.6 V	V_{CCO} – 0.1		V
		V_I = V_{IH}, I_{OH} = –50 µA V_{CCI} = 0.65 V, V_{CCO} = 0.65 V	0.55		
		V_I = V_{IH}, I_{OH} = –200 µA V_{CCI} = 0.76 V, V_{CCO} = 0.76 V	0.58		
		V_I = V_{IH}, I_{OH} = –500 µA V_{CCI} = 0.85 V, V_{CCO} = 0.85 V	0.65		
		V_I = V_{IH}, I_{OH} = –3 mA V_{CCI} = 1.1 V, V_{CCO} = 1.1 V	0.85		
		V_I = V_{IH}, I_{OH} = –6 mA V_{CCI} = 1.4 V, V_{CCO} = 1.4 V	1.05		
		V_I = V_{IH}, I_{OH} = –8 mA V_{CCI} = 1.65 V V_{CCO} = 1.65 V	1.2		
		V_I = V_{IH}, I_{OH} = –9 mA V_{CCI} = 2.3 V, V_{CCO} = 2.3 V	1.75		
		V_I = V_{IH}, I_{OH} = –12 mA V_{CCI} = 3 V, V_{CCO} = 3 V	2.3		

(1) All unused data inputs of the device must be held at V_{CCI} or GND to assure proper device operation. For more information, refer to the *Implications of Slow or Floating CMOS Inputs* application report.
(2) V_{CCI} is the V_{CC} associated with the input port.
(3) V_{CCO} is the V_{CC} associated with the output port.

Electrical Characteristics: –40°C ≤ T$_A$ ≤ +85°C (continued)

over recommended operating free-air temperature range (unless otherwise noted)[1]

PARAMETER		TEST CONDITIONS[2][3]	MIN	MAX	UNIT
V$_{OL}$	Low-level output voltage	V$_I$ = V$_{IL}$, I$_{OL}$ = 100 μA, V$_{CCA}$ = V$_{CCB}$ V$_{CCI}$ = 0.7 V – 3.6 V, V$_{CCO}$= 0.7 V – 3.6 V		0.1	V
		V$_I$ = V$_{IL}$, I$_{OL}$ = 50 μA V$_{CCI}$ = 0.65 V, V$_{CCO}$= 0.65 V		0.1	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 200 μA V$_{CCI}$ = 0.76 V V$_{CCO}$= 0.76 V		0.18	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 500 μA V$_{CCI}$ = 0.85 V, V$_{CCO}$= 0.85 V		0.2	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 3 mA V$_{CCI}$ = 1.1 V, V$_{CCO}$= 1.1 V		0.25	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 6 mA V$_{CCI}$ = 1.4 V, V$_{CCO}$= 1.4 V		0.35	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 8 mA V$_{CCI}$ = 1.65 V, V$_{CCO}$= 1.65 V		0.45	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 9 mA V$_{CCI}$ = 2.3 V, V$_{CCO}$= 2.3 V		0.55	
		V$_I$ = V$_{IL}$, I$_{OL}$ = 12 mA V$_{CCI}$ = 3 V, V$_{CCO}$= 3 V		0.7	
I$_I$	Input leakage current DIR	V$_I$ = V$_{CCA}$ or GND V$_{CCI}$ = 0.65 V – 3.6 V, V$_{CCO}$= 0.65 V – 3.6 V	−1	1	μA
I$_{off}$	Off-state current	A port: V$_I$ or V$_O$ = 0 to 3.6 V V$_{CCI}$ = 0 V, V$_{CCO}$= 0 – 3.6 V	−5	5	μA
		B port: V$_I$ or V$_O$ = 0 to 3.6 V V$_{CCI}$ = 0 – 3.6 V, V$_{CCO}$= 0 V	−5	5	
I$_{OZ}$	High-impedance-state output current	B port: V$_O$ = V$_{CCO}$ or GND, V$_I$ = V$_{CCI}$ or GND V$_{CCI}$ = 0 V, V$_{CCO}$= 3.6 V	−5	5	μA
		A port: V$_O$ = V$_{CCO}$ or GND, V$_I$ = V$_{CCI}$ or GND V$_{CCI}$ = 3.6 V, V$_{CCO}$= 0 V	−5	5	
I$_{CCA}$	V$_{CCA}$ supply current	V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 0.65 V – 3.6 V, V$_{CCO}$= 0.65 V – 3.6 V		6	μA
		V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 0 V, V$_{CCO}$= 3.6 V	-2		
		V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 3.6 V, V$_{CCO}$= 0 V		2	
I$_{CCB}$	V$_{CCB}$ supply current	V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 0.65 V – 3.6 V, V$_{CCO}$= 0.65 V – 3.6 V		6	μA
		V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 0 V, V$_{CCO}$= 3.6 V		2	
		V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 3.6 V, V$_{CCO}$= 0 V	-2		
I$_{CCA}$ + I$_{CCB}$	Combined supply current	V$_I$ = V$_{CCI}$ or GND, I$_O$ = 0 V$_{CCI}$ = 0.65 V – 3.6 V, V$_{CCO}$= 0.65 V – 3.6 V		6	μA
C$_I$	Input capacitance DIR	V$_I$ = 0V, 3.30 V V$_{CCI}$ = 3.3 V, V$_{CCO}$= 3.3 V		4.4	pF
C$_{I/O}$	Input-to-output internal capacitance	A Port: V$_O$ = 1.65V DC + 1 MHz, –16-dBm sine wave V$_{CCI}$ = 3.3 V, V$_{CCO}$= 0 V		5	pF
C$_{I/O}$	Input-to-output internal capacitance	B Port: V$_O$ = 1.65V DC + 1 MHz, –16-dBm sine wave V$_{CCI}$ = 0 V, V$_{CCO}$= 3.3 V		5	pF

Product Folder Links: *SN74AXC1T45*

6.6 Electrical Characteristics: –40°C ≤ T$_A$ ≤ +125°C

over recommended operating free-air temperature range (unless otherwise noted)[1]

PARAMETER		TEST CONDITIONS[2][3]	MIN	MAX	UNIT
V_{IH}	High-level input voltage	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.70		V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.70		
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCI} × 0.65		
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V	1.6		
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V	2		
V_{IL}	Low-level input voltage	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} x 0.30	V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} x 0.30	
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCI} x 0.35	
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V		0.7	
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V		0.8	
V_{IH}	High-level input voltage DIR	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.70		V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.70		
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V	V_{CCA} × 0.65		
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V	1.6		
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V	2		
V_{IL}	Low-level input voltage DIR	V_{CCI} = 0.65 V – 0.75 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} x 0.30	V
		V_{CCI} = 0.76 V – 1 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} x 0.30	
		V_{CCI} = 1.1 V – 1.95 V, V_{CCO} = 0.65 V – 3.60 V		V_{CCA} x 0.35	
		V_{CCI} = 2.3 V – 2.7 V, V_{CCO} = 0.65 V – 3.60 V		0.7	
		V_{CCI} = 3 V – 3.6 V, V_{CCO} = 0.65 V – 3.60 V		0.8	
V_{OH}	High-level output voltage	V_I = V_{IH}, I_{OH} = –100 µA , V_{CCA} = V_{CCB} V_{CCI} = 0.7 V – 3.6 V, V_{CCO} = 0.7 V – 3.6 V	V_{CCO} – 0.1		V
		V_I = V_{IH}, I_{OH} = –50 µA V_{CCI} = 0.65 V, V_{CCO} = 0.65 V	0.55		
		V_I = V_{IH}, I_{OH} = –200 µA V_{CCI} = 0.76 V, V_{CCO} = 0.76 V	0.58		
		V_I = V_{IH}, I_{OH} = –500 µA V_{CCI} = 0.85 V, V_{CCO} = 0.85 V	0.65		
		V_I = V_{IH} I_{OH} = –3 mA V_{CCI} = 1.1 V, V_{CCO} = 1.1 V	0.85		
		V_I = V_{IH}, I_{OH} = –6 mA V_{CCI} = 1.4 V, V_{CCO} = 1.4 V	1.05		
		V_I = V_{IH}, I_{OH} = –8 mA V_{CCI} = 1.65 V, V_{CCO} = 1.65 V	1.2		
		V_I = V_{IH}, I_{OH} = –9 mA V_{CCI} = 2.3 V, V_{CCO} = 2.3 V	1.75		
		V_I = V_{IH}, I_{OH} = –12 mA V_{CCI} = 3 V, V_{CCO} = 3 V	2.3		

(1) All unused data inputs of the device must be held at V_{CCI} or GND to assure proper device operation. For more information, refer to the *Implications of Slow or Floating CMOS Inputs* application report.
(2) V_{CCI} is the V_{CC} associated with the input port.
(3) V_{CCO} is the V_{CC} associated with the output port.

Electrical Characteristics: –40°C ≤ T$_A$ ≤ +125°C (continued)

over recommended operating free-air temperature range (unless otherwise noted)[1]

PARAMETER		TEST CONDITIONS[2] [3]	MIN	MAX	UNIT
V_{OL}	Low-level output voltage	$V_I = V_{IL}$, $I_{OL} = 100$ μA , $V_{CCA} = V_{CCB}$ $V_{CCI} = 0.7$ V – 3.6 V, $V_{CCO} = 0.7$ V – 3.6 V		0.1	V
		$V_I = V_{IL}$, $I_{OL} = 50$ μA $V_{CCI} = 0.65$ V, $V_{CCO} = 0.65$ V		0.1	
		$V_I = V_{IL}$, $I_{OL} = 200$ μA $V_{CCI} = 0.76$ V, $V_{CCO} = 0.76$ V		0.18	
		$V_I = V_{IL}$, $I_{OL} = 500$ μA $V_{CCI} = 0.85$ V, $V_{CCO} = 0.85$ V		0.2	
		$V_I = V_{IL}$, $I_{OL} = 3$ mA $V_{CCI} = 1.1$ V, $V_{CCO} = 1.1$ V		0.25	
		$V_I = V_{IL}$, $I_{OL} = 6$ mA $V_{CCI} = 1.4$ V, $V_{CCO} = 1.4$ V		0.35	
		$V_I = V_{IL}$, $I_{OL} = 8$ mA $V_{CCI} = 1.65$ V, $V_{CCO} = 1.65$ V		0.45	
		$V_I = V_{IL}$, $I_{OL} = 9$ mA $V_{CCI} = 2.3$ V, $V_{CCO} = 2.3$ V		0.55	
		$V_I = V_{IL}$, $I_{OL} = 12$ mA $V_{CCI} = 3$ V, $V_{CCO} = 3$ V		0.7	
I_I	Input leakage current DIR	$V_I = V_{CCA}$ or GND $V_{CCI} = 0.65$ V – 3.6 V, $V_{CCO} = 0.65$ V – 3.6 V	-1.5	1.5	μA
I_{off}	Off-state current	A port: V_I or $V_O = 0$ to 3.6 V $V_{CCI} = 0$ V, $V_{CCO} = 0 – 3.6$ V	-7.5	7.5	μA
		B port: V_I or $V_O = 0$ to 3.6 V $V_{CCI} = 0 – 3.6$ V, $V_{CCO} = 0$ V	-7.5	7.5	
I_{OZ}	High-impedance-state output current	B port: $V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND $V_{CCI} = 0$ V, $V_{CCO} = 3.6$ V	-7.5	7.5	μA
		A port: $V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND $V_{CCI} = 3.6$ V, $V_{CCO} = 0$ V	-7.5	7.5	
I_{CCA}	V_{CCA} supply current	$V_I = V_{CCI}$ or GND, $I_O = 0$ $V_{CCI} = 0.65$ V – 3.6 V, $V_{CCO} = 0.65$ V – 3.6 V		8	μA
		$V_I = V_{CCI}$ or GND, $I_O = 0$ $V_{CCI} = 0$ V, $V_{CCO} = 3.6$ V	-8		
		$V_I = V_{CCI}$ or GND, $I_O = 0$ $V_{CCI} = 3.6$ V, $V_{CCO} = 0$ V		8	
I_{CCB}	V_{CCB} supply current	$V_I = V_{CCI}$ or GND, I_O $V_{CCI} = 0.65$ V – 3.6 V, $V_{CCO} = 0.65$ V – 3.6 V		8.5	μA
		$V_I = V_{CCI}$ or GND, I_O $V_{CCI} = 0$ V, $V_{CCO} = 3.6$ V		8	
		$V_I = V_{CCI}$ or GND, I_O $V_{CCI} = 3.6$ V, $V_{CCO} = 0$ V	-8		
$I_{CCA} + I_{CCB}$	Combined supply current	$V_I = V_{CCI}$ or GND, $I_O = 0$ $V_{CCI} = 0.65$ V – 3.6 V, $V_{CCO} = 0.65$ V – 3.6 V		14	μA
C_I	Input capacitance DIR	$V_I = 0$V, 3.30V $V_{CCI} = 3.3$ V, $V_{CCO} = 3.3$ V		4.4	pF
$C_{I/O}$	Input-to-output internal capacitance	A Port: $V_O = 1.65$V DC + 1 MHz, –16-dBm sine wave $V_{CCI} = 3.3$ V, $V_{CCO} = 0$ V		5	pF
$C_{I/O}$	Input-to-output internal capacitance	B Port: $V_O = 1.65$V DC + 1 MHz, –16-dBm sine wave $V_{CCI} = 0$ V, $V_{CCO} = 3.3$ V		5	pF

6.7 Switching Characteristics: V_{CCA} = 0.7 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 0.7 V (see *Figure 1*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	22	173	ns
		V_{CCB} = 0.8 V ± 0.04 V	16	117	
		V_{CCB} = 0.9 V ± 0.045 V	14	85	
		V_{CCB} = 1.2 V ± 0.1 V	10	51	
		V_{CCB} = 1.5 V ± 0.1 V	9	50	
		V_{CCB} = 1.8 V ± 0.15 V	8	53	
		V_{CCB} = 2.5 V ± 0.2 V	8	65	
		V_{CCB} = 3.3 V ± 0.3 V	10	143	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	22	173	ns
		V_{CCB} = 0.8 V ± 0.04 V	17	154	
		V_{CCB} = 0.9 V ± 0.045 V	15	127	
		V_{CCB} = 1.2 V ± 0.1 V	12	88	
		V_{CCB} = 1.5 V ± 0.1 V	11	83	
		V_{CCB} = 1.8 V ± 0.15 V	10	82	
		V_{CCB} = 2.5 V ± 0.2 V	10	80	
		V_{CCB} = 3.3 V ± 0.3 V	9	80	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	67	143	ns
		V_{CCB} = 0.8 V ± 0.04 V	67	143	
		V_{CCB} = 0.9 V ± 0.045 V	67	143	
		V_{CCB} = 1.2 V ± 0.1 V	67	143	
		V_{CCB} = 1.5 V ± 0.1 V	67	143	
		V_{CCB} = 1.8 V ± 0.15 V	67	143	
		V_{CCB} = 2.5 V ± 0.2 V	67	143	
		V_{CCB} = 3.3 V ± 0.3 V	67	143	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	71	163	ns
		V_{CCB} = 0.8 V ± 0.04 V	57	123	
		V_{CCB} = 0.9 V ± 0.045 V	49	100	
		V_{CCB} = 1.2 V ± 0.1 V	18	50	
		V_{CCB} = 1.5 V ± 0.1 V	15	45	
		V_{CCB} = 1.8 V ± 0.15 V	14	49	
		V_{CCB} = 2.5 V ± 0.2 V	13	61	
		V_{CCB} = 3.3 V ± 0.3 V	14	109	

Switching Characteristics: V_{CCA} = 0.7 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.7 V (see *Figure 1*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		389	ns
		V_{CCB} = 0.8 V ± 0.04 V		331	
		V_{CCB} = 0.9 V ± 0.045 V		287	
		V_{CCB} = 1.2 V ± 0.1 V		143	
		V_{CCB} = 1.5 V ± 0.1 V		134	
		V_{CCB} = 1.8 V ± 0.15 V		137	
		V_{CCB} = 2.5 V ± 0.2 V		147	
		V_{CCB} = 3.3 V ± 0.3 V		200	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		369	ns
		V_{CCB} = 0.8 V ± 0.04 V		313	
		V_{CCB} = 0.9 V ± 0.045 V		281	
		V_{CCB} = 1.2 V ± 0.1 V		247	
		V_{CCB} = 1.5 V ± 0.1 V		246	
		V_{CCB} = 1.8 V ± 0.15 V		249	
		V_{CCB} = 2.5 V ± 0.2 V		261	
		V_{CCB} = 3.3 V ± 0.3 V		339	

Product Folder Links: *SN74AXC1T45*

6.8 Switching Characteristics: V_{CCA} = 0.7 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 0.7 V (see *Figure 9*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	20	173	ns
		V_{CCB} = 0.8 V ± 0.04 V	15	117	
		V_{CCB} = 0.9 V ± 0.045 V	13	85	
		V_{CCB} = 1.2 V ± 0.1 V	10	51	
		V_{CCB} = 1.5 V ± 0.1 V	8	50	
		V_{CCB} = 1.8 V ± 0.15 V	8	53	
		V_{CCB} = 2.5 V ± 0.2 V	8	65	
		V_{CCB} = 3.3 V ± 0.3 V	9	143	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	20	173	ns
		V_{CCB} = 0.8 V ± 0.04 V	16	154	
		V_{CCB} = 0.9 V ± 0.045 V	14	127	
		V_{CCB} = 1.2 V ± 0.1 V	12	88	
		V_{CCB} = 1.5 V ± 0.1 V	11	83	
		V_{CCB} = 1.8 V ± 0.15 V	10	82	
		V_{CCB} = 2.5 V ± 0.2 V	9	80	
		V_{CCB} = 3.3 V ± 0.3 V	9	80	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	67	143	ns
		V_{CCB} = 0.8 V ± 0.04 V	67	143	
		V_{CCB} = 0.9 V ± 0.045 V	67	143	
		V_{CCB} = 1.2 V ± 0.1 V	67	143	
		V_{CCB} = 1.5 V ± 0.1 V	67	143	
		V_{CCB} = 1.8 V ± 0.15 V	67	143	
		V_{CCB} = 2.5 V ± 0.2 V	67	143	
		V_{CCB} = 3.3 V ± 0.3 V	67	143	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	70	163	ns
		V_{CCB} = 0.8 V ± 0.04 V	57	123	
		V_{CCB} = 0.9 V ± 0.045 V	49	100	
		V_{CCB} = 1.2 V ± 0.1 V	18	50	
		V_{CCB} = 1.5 V ± 0.1 V	15	45	
		V_{CCB} = 1.8 V ± 0.15 V	14	49	
		V_{CCB} = 2.5 V ± 0.2 V	13	161	
		V_{CCB} = 3.3 V ± 0.3 V	14	109	

Switching Characteristics: V_{CCA} = 0.7 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.7 V (see *Figure 9*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		406	ns
		V_{CCB} = 0.8 V ± 0.04 V		333	
		V_{CCB} = 0.9 V ± 0.045 V		287	
		V_{CCB} = 1.2 V ± 0.1 V		143	
		V_{CCB} = 1.5 V ± 0.1 V		134	
		V_{CCB} = 1.8 V ± 0.15 V		137	
		V_{CCB} = 2.5 V ± 0.2 V		147	
		V_{CCB} = 3.3 V ± 0.3 V		200	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		395	ns
		V_{CCB} = 0.8 V ± 0.04 V		339	
		V_{CCB} = 0.9 V ± 0.045 V		307	
		V_{CCB} = 1.2 V ± 0.1 V		273	
		V_{CCB} = 1.5 V ± 0.1 V		272	
		V_{CCB} = 1.8 V ± 0.15 V		275	
		V_{CCB} = 2.5 V ± 0.2 V		287	
		V_{CCB} = 3.3 V ± 0.3 V		365	

Product Folder Links: *SN74AXC1T45*

6.9 Switching Characteristics: V_{CCA} = 0.8 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 0.8 V (see *Figure 2*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	17	153	ns
		V_{CCB} = 0.8 V ± 0.04 V	13	95	
		V_{CCB} = 0.9 V ± 0.045 V	11	64	
		V_{CCB} = 1.2 V ± 0.1 V	8	33	
		V_{CCB} = 1.5 V ± 0.1 V	6	27	
		V_{CCB} = 1.8 V ± 0.15 V	6	26	
		V_{CCB} = 2.5 V ± 0.2 V	5	27	
		V_{CCB} = 3.3 V ± 0.3 V	6	36	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	16	117	ns
		V_{CCB} = 0.8 V ± 0.04 V	13	96	
		V_{CCB} = 0.9 V ± 0.045 V	11	78	
		V_{CCB} = 1.2 V ± 0.1 V	9	52	
		V_{CCB} = 1.5 V ± 0.1 V	7	42	
		V_{CCB} = 1.8 V ± 0.15 V	7	41	
		V_{CCB} = 2.5 V ± 0.2 V	6	40	
		V_{CCB} = 3.3 V ± 0.3 V	6	39	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	53	100	ns
		V_{CCB} = 0.8 V ± 0.04 V	53	100	
		V_{CCB} = 0.9 V ± 0.045 V	53	100	
		V_{CCB} = 1.2 V ± 0.1 V	53	100	
		V_{CCB} = 1.5 V ± 0.1 V	53	100	
		V_{CCB} = 1.8 V ± 0.15 V	53	100	
		V_{CCB} = 2.5 V ± 0.2 V	53	100	
		V_{CCB} = 3.3 V ± 0.3 V	53	100	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	69	151	ns
		V_{CCB} = 0.8 V ± 0.04 V	55	111	
		V_{CCB} = 0.9 V ± 0.045 V	47	88	
		V_{CCB} = 1.2 V ± 0.1 V	16	38	
		V_{CCB} = 1.5 V ± 0.1 V	13	32	
		V_{CCB} = 1.8 V ± 0.15 V	12	30	
		V_{CCB} = 2.5 V ± 0.2 V	10	30	
		V_{CCB} = 3.3 V ± 0.3 V	11	38	

Switching Characteristics: V_{CCA} = 0.8 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.8 V (see *Figure 2*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		321	ns
		V_{CCB} = 0.8 V ± 0.04 V		261	
		V_{CCB} = 0.9 V ± 0.045 V		226	
		V_{CCB} = 1.2 V ± 0.1 V		96	
		V_{CCB} = 1.5 V ± 0.1 V		80	
		V_{CCB} = 1.8 V ± 0.15 V		78	
		V_{CCB} = 2.5 V ± 0.2 V		76	
		V_{CCB} = 3.3 V ± 0.3 V		87	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		309	ns
		V_{CCB} = 0.8 V ± 0.04 V		251	
		V_{CCB} = 0.9 V ± 0.045 V		220	
		V_{CCB} = 1.2 V ± 0.1 V		189	
		V_{CCB} = 1.5 V ± 0.1 V		183	
		V_{CCB} = 1.8 V ± 0.15 V		182	
		V_{CCB} = 2.5 V ± 0.2 V		183	
		V_{CCB} = 3.3 V ± 0.3 V		192	

Product Folder Links: *SN74AXC1T45*

6.10 Switching Characteristics: V$_{CCA}$ = 0.8 V, T$_A$ = –40°C to +125°C

over recommended operating free-air temperature range, V$_{CCA}$ = 0.8 V (see *Figure 10*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t$_{pd}$ Propagation delay	A-to-B	V$_{CCB}$ = 0.7 V ± 0.05 V	16	153	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	12	95	
		V$_{CCB}$ = 0.9 V ± 0.045 V	11	64	
		V$_{CCB}$ = 1.2 V ± 0.1 V	8	33	
		V$_{CCB}$ = 1.5 V ± 0.1 V	6	27	
		V$_{CCB}$ = 1.8 V ± 0.15 V	6	26	
		V$_{CCB}$ = 2.5 V ± 0.2 V	5	27	
		V$_{CCB}$ = 3.3 V ± 0.3 V	6	36	
	B-to-A	V$_{CCB}$ = 0.7 V ± 0.05 V	15	117	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	12	96	
		V$_{CCB}$ = 0.9 V ± 0.045 V	11	78	
		V$_{CCB}$ = 1.2 V ± 0.1 V	8	52	
		V$_{CCB}$ = 1.5 V ± 0.1 V	7	42	
		V$_{CCB}$ = 1.8 V ± 0.15 V	7	41	
		V$_{CCB}$ = 2.5 V ± 0.2 V	6	40	
		V$_{CCB}$ = 3.3 V ± 0.3 V	6	39	
t$_{dis}$ Disable time	Port A	V$_{CCB}$ = 0.7 V ± 0.05 V	53	100	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	53	100	
		V$_{CCB}$ = 0.9 V ± 0.045 V	53	100	
		V$_{CCB}$ = 1.2 V ± 0.1 V	53	100	
		V$_{CCB}$ = 1.5 V ± 0.1 V	53	100	
		V$_{CCB}$ = 1.8 V ± 0.15 V	53	100	
		V$_{CCB}$ = 2.5 V ± 0.2 V	53	100	
		V$_{CCB}$ = 3.3 V ± 0.3 V	53	100	
	Port B	V$_{CCB}$ = 0.7 V ± 0.05 V	68	151	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	55	111	
		V$_{CCB}$ = 0.9 V ± 0.045 V	47	88	
		V$_{CCB}$ = 1.2 V ± 0.1 V	16	40	
		V$_{CCB}$ = 1.5 V ± 0.1 V	13	33	
		V$_{CCB}$ = 1.8 V ± 0.15 V	12	30	
		V$_{CCB}$ = 2.5 V ± 0.2 V	10	30	
		V$_{CCB}$ = 3.3 V ± 0.3 V	11	38	

Switching Characteristics: V_{CCA} = 0.8 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.8 V (see *Figure 10*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		341	ns
		V_{CCB} = 0.8 V ± 0.04 V		266	
		V_{CCB} = 0.9 V ± 0.045 V		229	
		V_{CCB} = 1.2 V ± 0.1 V		97	
		V_{CCB} = 1.5 V ± 0.1 V		80	
		V_{CCB} = 1.8 V ± 0.15 V		78	
		V_{CCB} = 2.5 V ± 0.2 V		76	
		V_{CCB} = 3.3 V ± 0.3 V		87	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		317	ns
		V_{CCB} = 0.8 V ± 0.04 V		259	
		V_{CCB} = 0.9 V ± 0.045 V		228	
		V_{CCB} = 1.2 V ± 0.1 V		197	
		V_{CCB} = 1.5 V ± 0.1 V		191	
		V_{CCB} = 1.8 V ± 0.15 V		190	
		V_{CCB} = 2.5 V ± 0.2 V		191	
		V_{CCB} = 3.3 V ± 0.3 V		200	

Product Folder Links: *SN74AXC1T45*

6.11 Switching Characteristics: V_{CCA} = 0.9 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 0.9 V (see *Figure 3*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	15	126	ns
		V_{CCB} = 0.8 V ± 0.04 V	11	78	
		V_{CCB} = 0.9 V ± 0.045 V	9	52	
		V_{CCB} = 1.2 V ± 0.1 V	6	23	
		V_{CCB} = 1.5 V ± 0.1 V	5	18	
		V_{CCB} = 1.8 V ± 0.15 V	5	16	
		V_{CCB} = 2.5 V ± 0.2 V	4	15	
		V_{CCB} = 3.3 V ± 0.3 V	4	18	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	14	85	ns
		V_{CCB} = 0.8 V ± 0.04 V	11	64	
		V_{CCB} = 0.9 V ± 0.045 V	9	53	
		V_{CCB} = 1.2 V ± 0.1 V	7	40	
		V_{CCB} = 1.5 V ± 0.1 V	6	28	
		V_{CCB} = 1.8 V ± 0.15 V	5	24	
		V_{CCB} = 2.5 V ± 0.2 V	5	22	
		V_{CCB} = 3.3 V ± 0.3 V	5	21	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	27	75	ns
		V_{CCB} = 0.8 V ± 0.04 V	27	75	
		V_{CCB} = 0.9 V ± 0.045 V	27	75	
		V_{CCB} = 1.2 V ± 0.1 V	27	75	
		V_{CCB} = 1.5 V ± 0.1 V	27	75	
		V_{CCB} = 1.8 V ± 0.15 V	27	75	
		V_{CCB} = 2.5 V ± 0.2 V	27	75	
		V_{CCB} = 3.3 V ± 0.3 V	27	75	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	68	144	ns
		V_{CCB} = 0.8 V ± 0.04 V	54	105	
		V_{CCB} = 0.9 V ± 0.045 V	47	82	
		V_{CCB} = 1.2 V ± 0.1 V	15	32	
		V_{CCB} = 1.5 V ± 0.1 V	12	25	
		V_{CCB} = 1.8 V ± 0.15 V	11	24	
		V_{CCB} = 2.5 V ± 0.2 V	9	21	
		V_{CCB} = 3.3 V ± 0.3 V	10	23	

Submit Documentation Feedback   19

Product Folder Links: *SN74AXC1T45*

Switching Characteristics: V_{CCA} = 0.9 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.9 V (see *Figure 3*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		282	ns
		V_{CCB} = 0.8 V ± 0.04 V		223	
		V_{CCB} = 0.9 V ± 0.045 V		195	
		V_{CCB} = 1.2 V ± 0.1 V		77	
		V_{CCB} = 1.5 V ± 0.1 V		59	
		V_{CCB} = 1.8 V ± 0.15 V		54	
		V_{CCB} = 2.5 V ± 0.2 V		48	
		V_{CCB} = 3.3 V ± 0.3 V		54	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		262	ns
		V_{CCB} = 0.8 V ± 0.04 V		214	
		V_{CCB} = 0.9 V ± 0.045 V		188	
		V_{CCB} = 1.2 V ± 0.1 V		159	
		V_{CCB} = 1.5 V ± 0.1 V		154	
		V_{CCB} = 1.8 V ± 0.15 V		152	
		V_{CCB} = 2.5 V ± 0.2 V		151	
		V_{CCB} = 3.3 V ± 0.3 V		154	

Product Folder Links: *SN74AXC1T45*

6.12 Switching Characteristics: V_{CCA} = 0.9 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 0.9 V (see *Figure 11*)

	PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
t_{pd}	Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	14	126	ns
			V_{CCB} = 0.8 V ± 0.04 V	11	78	
			V_{CCB} = 0.9 V ± 0.045 V	9	52	
			V_{CCB} = 1.2 V ± 0.1 V	6	23	
			V_{CCB} = 1.5 V ± 0.1 V	5	18	
			V_{CCB} = 1.8 V ± 0.15 V	5	16	
			V_{CCB} = 2.5 V ± 0.2 V	4	15	
			V_{CCB} = 3.3 V ± 0.3 V	4	18	
		B-to-A	V_{CCB} = 0.7 V ± 0.05 V	13	85	ns
			V_{CCB} = 0.8 V ± 0.04 V	11	64	
			V_{CCB} = 0.9 V ± 0.045 V	9	53	
			V_{CCB} = 1.2 V ± 0.1 V	7	40	
			V_{CCB} = 1.5 V ± 0.1 V	6	28	
			V_{CCB} = 1.8 V ± 0.15 V	5	24	
			V_{CCB} = 2.5 V ± 0.2 V	5	22	
			V_{CCB} = 3.3 V ± 0.3 V	5	21	
t_{dis}	Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	27	79	ns
			V_{CCB} = 0.8 V ± 0.04 V	27	79	
			V_{CCB} = 0.9 V ± 0.045 V	27	79	
			V_{CCB} = 1.2 V ± 0.1 V	27	79	
			V_{CCB} = 1.5 V ± 0.1 V	27	79	
			V_{CCB} = 1.8 V ± 0.15 V	27	79	
			V_{CCB} = 2.5 V ± 0.2 V	27	79	
			V_{CCB} = 3.3 V ± 0.3 V	27	79	
		Port B	V_{CCB} = 0.7 V ± 0.05 V	68	144	ns
			V_{CCB} = 0.8 V ± 0.04 V	54	105	
			V_{CCB} = 0.9 V ± 0.045 V	47	83	
			V_{CCB} = 1.2 V ± 0.1 V	15	36	
			V_{CCB} = 1.5 V ± 0.1 V	12	28	
			V_{CCB} = 1.8 V ± 0.15 V	11	26	
			V_{CCB} = 2.5 V ± 0.2 V	9	21	
			V_{CCB} = 3.3 V ± 0.3 V	10	23	

Product Folder Links: *SN74AXC1T45*

Switching Characteristics: V_{CCA} = 0.9 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 0.9 V (see *Figure 11*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		304	ns
		V_{CCB} = 0.8 V ± 0.04 V		229	
		V_{CCB} = 0.9 V ± 0.045 V		199	
		V_{CCB} = 1.2 V ± 0.1 V		81	
		V_{CCB} = 1.5 V ± 0.1 V		62	
		V_{CCB} = 1.8 V ± 0.15 V		56	
		V_{CCB} = 2.5 V ± 0.2 V		49	
		V_{CCB} = 3.3 V ± 0.3 V		54	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		269	ns
		V_{CCB} = 0.8 V ± 0.04 V		221	
		V_{CCB} = 0.9 V ± 0.045 V		195	
		V_{CCB} = 1.2 V ± 0.1 V		166	
		V_{CCB} = 1.5 V ± 0.1 V		161	
		V_{CCB} = 1.8 V ± 0.15 V		159	
		V_{CCB} = 2.5 V ± 0.2 V		158	
		V_{CCB} = 3.3 V ± 0.3 V		161	

6.13 Switching Characteristics: V_{CCA} = 1.2 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 4)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	12	87	ns
		V_{CCB} = 0.8 V ± 0.04 V	9	52	
		V_{CCB} = 0.9 V ± 0.045 V	7	39	
		V_{CCB} = 1.2 V ± 0.1 V	5	15	
		V_{CCB} = 1.5 V ± 0.1 V	4	9	
		V_{CCB} = 1.8 V ± 0.15 V	3	8	
		V_{CCB} = 2.5 V ± 0.2 V	3	7	
		V_{CCB} = 3.3 V ± 0.3 V	3	7	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	10	51	ns
		V_{CCB} = 0.8 V ± 0.04 V	8	33	
		V_{CCB} = 0.9 V ± 0.045 V	6	23	
		V_{CCB} = 1.2 V ± 0.1 V	5	15	
		V_{CCB} = 1.5 V ± 0.1 V	4	12	
		V_{CCB} = 1.8 V ± 0.15 V	3	10	
		V_{CCB} = 2.5 V ± 0.2 V	3	7	
		V_{CCB} = 3.3 V ± 0.3 V	2	7	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	10	22	ns
		V_{CCB} = 0.8 V ± 0.04 V	10	22	
		V_{CCB} = 0.9 V ± 0.045 V	10	22	
		V_{CCB} = 1.2 V ± 0.1 V	10	22	
		V_{CCB} = 1.5 V ± 0.1 V	10	22	
		V_{CCB} = 1.8 V ± 0.15 V	10	22	
		V_{CCB} = 2.5 V ± 0.2 V	10	22	
		V_{CCB} = 3.3 V ± 0.3 V	10	22	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	67	137	ns
		V_{CCB} = 0.8 V ± 0.04 V	53	98	
		V_{CCB} = 0.9 V ± 0.045 V	46	74	
		V_{CCB} = 1.2 V ± 0.1 V	14	24	
		V_{CCB} = 1.5 V ± 0.1 V	11	18	
		V_{CCB} = 1.8 V ± 0.15 V	10	16	
		V_{CCB} = 2.5 V ± 0.2 V	8	13	
		V_{CCB} = 3.3 V ± 0.3 V	8	13	

Switching Characteristics: V_{CCA} = 1.2 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 4)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		240	ns
		V_{CCB} = 0.8 V ± 0.04 V		185	
		V_{CCB} = 0.9 V ± 0.045 V		157	
		V_{CCB} = 1.2 V ± 0.1 V		45	
		V_{CCB} = 1.5 V ± 0.1 V		36	
		V_{CCB} = 1.8 V ± 0.15 V		33	
		V_{CCB} = 2.5 V ± 0.2 V		26	
		V_{CCB} = 3.3 V ± 0.3 V		29	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		115	ns
		V_{CCB} = 0.8 V ± 0.04 V		80	
		V_{CCB} = 0.9 V ± 0.045 V		67	
		V_{CCB} = 1.2 V ± 0.1 V		43	
		V_{CCB} = 1.5 V ± 0.1 V		37	
		V_{CCB} = 1.8 V ± 0.15 V		36	
		V_{CCB} = 2.5 V ± 0.2 V		35	
		V_{CCB} = 3.3 V ± 0.3 V		35	

Product Folder Links: *SN74AXC1T45*

6.14 Switching Characteristics: V_{CCA} = 1.2 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see *Figure 12*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	12	87	ns
		V_{CCB} = 0.8 V ± 0.04 V	8	52	
		V_{CCB} = 0.9 V ± 0.045 V	7	39	
		V_{CCB} = 1.2 V ± 0.1 V	5	15	
		V_{CCB} = 1.5 V ± 0.1 V	4	10	
		V_{CCB} = 1.8 V ± 0.15 V	3	9	
		V_{CCB} = 2.5 V ± 0.2 V	3	7	
		V_{CCB} = 3.3 V ± 0.3 V	3	8	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	10	51	ns
		V_{CCB} = 0.8 V ± 0.04 V	8	33	
		V_{CCB} = 0.9 V ± 0.045 V	6	23	
		V_{CCB} = 1.2 V ± 0.1 V	5	15	
		V_{CCB} = 1.5 V ± 0.1 V	4	12	
		V_{CCB} = 1.8 V ± 0.15 V	3	10	
		V_{CCB} = 2.5 V ± 0.2 V	3	8	
		V_{CCB} = 3.3 V ± 0.3 V	2	7	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	10	29	ns
		V_{CCB} = 0.8 V ± 0.04 V	10	29	
		V_{CCB} = 0.9 V ± 0.045 V	10	29	
		V_{CCB} = 1.2 V ± 0.1 V	10	29	
		V_{CCB} = 1.5 V ± 0.1 V	10	29	
		V_{CCB} = 1.8 V ± 0.15 V	10	29	
		V_{CCB} = 2.5 V ± 0.2 V	10	29	
		V_{CCB} = 3.3 V ± 0.3 V	10	29	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	67	137	ns
		V_{CCB} = 0.8 V ± 0.04 V	53	98	
		V_{CCB} = 0.9 V ± 0.045 V	46	78	
		V_{CCB} = 1.2 V ± 0.1 V	14	30	
		V_{CCB} = 1.5 V ± 0.1 V	11	23	
		V_{CCB} = 1.8 V ± 0.15 V	10	21	
		V_{CCB} = 2.5 V ± 0.2 V	8	17	
		V_{CCB} = 3.3 V ± 0.3 V	8	16	

Switching Characteristics: V_{CCA} = 1.2 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see *Figure 12*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		265	ns
		V_{CCB} = 0.8 V ± 0.04 V		193	
		V_{CCB} = 0.9 V ± 0.045 V		164	
		V_{CCB} = 1.2 V ± 0.1 V		51	
		V_{CCB} = 1.5 V ± 0.1 V		41	
		V_{CCB} = 1.8 V ± 0.15 V		37	
		V_{CCB} = 2.5 V ± 0.2 V		30	
		V_{CCB} = 3.3 V ± 0.3 V		32	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		121	ns
		V_{CCB} = 0.8 V ± 0.04 V		86	
		V_{CCB} = 0.9 V ± 0.045 V		73	
		V_{CCB} = 1.2 V ± 0.1 V		49	
		V_{CCB} = 1.5 V ± 0.1 V		44	
		V_{CCB} = 1.8 V ± 0.15 V		43	
		V_{CCB} = 2.5 V ± 0.2 V		41	
		V_{CCB} = 3.3 V ± 0.3 V		42	

Product Folder Links: *SN74AXC1T45*

6.15 Switching Characteristics: $V_{CCA} = 1.5$ V, $T_A = -40°C$ to $+85°C$

over recommended operating free-air temperature range, $V_{CCA} = 1.5$ V (see *Figure 5*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	$V_{CCB} = 0.7$ V $\pm$ 0.05 V	11	83	ns
		$V_{CCB} = 0.8$ V $\pm$ 0.04 V	7	42	
		$V_{CCB} = 0.9$ V $\pm$ 0.045 V	6	28	
		$V_{CCB} = 1.2$ V $\pm$ 0.1 V	4	12	
		$V_{CCB} = 1.5$ V $\pm$ 0.1 V	3	8	
		$V_{CCB} = 1.8$ V $\pm$ 0.15 V	3	7	
		$V_{CCB} = 2.5$ V $\pm$ 0.2 V	2	5	
		$V_{CCB} = 3.3$ V $\pm$ 0.3 V	2	5	
	B-to-A	$V_{CCB} = 0.7$ V $\pm$ 0.05 V	9	50	
		$V_{CCB} = 0.8$ V $\pm$ 0.04 V	6	28	
		$V_{CCB} = 0.9$ V $\pm$ 0.045 V	5	18	
		$V_{CCB} = 1.2$ V $\pm$ 0.1 V	4	10	
		$V_{CCB} = 1.5$ V $\pm$ 0.1 V	3	8	
		$V_{CCB} = 1.8$ V $\pm$ 0.15 V	2	7	
		$V_{CCB} = 2.5$ V $\pm$ 0.2 V	2	5	
		$V_{CCB} = 3.3$ V $\pm$ 0.3 V	2	4	
t_{dis} Disable time	Port A	$V_{CCB} = 0.7$ V $\pm$ 0.05 V	6	15	ns
		$V_{CCB} = 0.8$ V $\pm$ 0.04 V	6	15	
		$V_{CCB} = 0.9$ V $\pm$ 0.045 V	6	15	
		$V_{CCB} = 1.2$ V $\pm$ 0.1 V	6	15	
		$V_{CCB} = 1.5$ V $\pm$ 0.1 V	6	15	
		$V_{CCB} = 1.8$ V $\pm$ 0.15 V	6	15	
		$V_{CCB} = 2.5$ V $\pm$ 0.2 V	6	15	
		$V_{CCB} = 3.3$ V $\pm$ 0.3 V	6	15	
	Port B	$V_{CCB} = 0.7$ V $\pm$ 0.05 V	67	136	
		$V_{CCB} = 0.8$ V $\pm$ 0.04 V	53	96	
		$V_{CCB} = 0.9$ V $\pm$ 0.045 V	45	72	
		$V_{CCB} = 1.2$ V $\pm$ 0.1 V	14	22	
		$V_{CCB} = 1.5$ V $\pm$ 0.1 V	11	16	
		$V_{CCB} = 1.8$ V $\pm$ 0.15 V	10	14	
		$V_{CCB} = 2.5$ V $\pm$ 0.2 V	8	11	
		$V_{CCB} = 3.3$ V $\pm$ 0.3 V	7	11	

Switching Characteristics: V_{CCA} = 1.5 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.5 V (see *Figure 5*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		238	ns
		V_{CCB} = 0.8 V ± 0.04 V		178	
		V_{CCB} = 0.9 V ± 0.045 V		151	
		V_{CCB} = 1.2 V ± 0.1 V		38	
		V_{CCB} = 1.5 V ± 0.1 V		30	
		V_{CCB} = 1.8 V ± 0.15 V		28	
		V_{CCB} = 2.5 V ± 0.2 V		22	
		V_{CCB} = 3.3 V ± 0.3 V		24	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		104	
		V_{CCB} = 0.8 V ± 0.04 V		63	
		V_{CCB} = 0.9 V ± 0.045 V		49	
		V_{CCB} = 1.2 V ± 0.1 V		33	
		V_{CCB} = 1.5 V ± 0.1 V		29	
		V_{CCB} = 1.8 V ± 0.15 V		28	
		V_{CCB} = 2.5 V ± 0.2 V		26	
		V_{CCB} = 3.3 V ± 0.3 V		26	

Product Folder Links: *SN74AXC1T45*

6.16 Switching Characteristics: V_{CCA} = 1.5 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 1.5 V (see *Figure 13*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	10	83	ns
		V_{CCB} = 0.8 V ± 0.04 V	7	42	
		V_{CCB} = 0.9 V ± 0.045 V	6	28	
		V_{CCB} = 1.2 V ± 0.1 V	4	12	
		V_{CCB} = 1.5 V ± 0.1 V	3	9	
		V_{CCB} = 1.8 V ± 0.15 V	3	8	
		V_{CCB} = 2.5 V ± 0.2 V	2	6	
		V_{CCB} = 3.3 V ± 0.3 V	2	6	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	8	50	
		V_{CCB} = 0.8 V ± 0.04 V	6	28	
		V_{CCB} = 0.9 V ± 0.045 V	5	18	
		V_{CCB} = 1.2 V ± 0.1 V	4	10	
		V_{CCB} = 1.5 V ± 0.1 V	3	9	
		V_{CCB} = 1.8 V ± 0.15 V	2	8	
		V_{CCB} = 2.5 V ± 0.2 V	2	6	
		V_{CCB} = 3.3 V ± 0.3 V	2	5	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	6	20	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	20	
		V_{CCB} = 0.9 V ± 0.045 V	6	20	
		V_{CCB} = 1.2 V ± 0.1 V	6	20	
		V_{CCB} = 1.5 V ± 0.1 V	6	20	
		V_{CCB} = 1.8 V ± 0.15 V	6	20	
		V_{CCB} = 2.5 V ± 0.2 V	6	20	
		V_{CCB} = 3.3 V ± 0.3 V	6	20	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	66	136	
		V_{CCB} = 0.8 V ± 0.04 V	53	96	
		V_{CCB} = 0.9 V ± 0.045 V	45	76	
		V_{CCB} = 1.2 V ± 0.1 V	14	29	
		V_{CCB} = 1.5 V ± 0.1 V	11	21	
		V_{CCB} = 1.8 V ± 0.15 V	10	19	
		V_{CCB} = 2.5 V ± 0.2 V	8	15	
		V_{CCB} = 3.3 V ± 0.3 V	7	14	

Product Folder Links: *SN74AXC1T45*

Switching Characteristics: V_{CCA} = 1.5 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.5 V (see *Figure 13*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		263	ns
		V_{CCB} = 0.8 V ± 0.04 V		186	
		V_{CCB} = 0.9 V ± 0.045 V		157	
		V_{CCB} = 1.2 V ± 0.1 V		44	
		V_{CCB} = 1.5 V ± 0.1 V		36	
		V_{CCB} = 1.8 V ± 0.15 V		33	
		V_{CCB} = 2.5 V ± 0.2 V		26	
		V_{CCB} = 3.3 V ± 0.3 V		27	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		109	
		V_{CCB} = 0.8 V ± 0.04 V		68	
		V_{CCB} = 0.9 V ± 0.045 V		54	
		V_{CCB} = 1.2 V ± 0.1 V		38	
		V_{CCB} = 1.5 V ± 0.1 V		35	
		V_{CCB} = 1.8 V ± 0.15 V		34	
		V_{CCB} = 2.5 V ± 0.2 V		32	
		V_{CCB} = 3.3 V ± 0.3 V		32	

Product Folder Links: *SN74AXC1T45*

6.17 Switching Characteristics: V_{CCA} = 1.8 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 1.8 V (see *Figure 6*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	10	81	ns
		V_{CCB} = 0.8 V ± 0.04 V	7	41	
		V_{CCB} = 0.9 V ± 0.045 V	5	24	
		V_{CCB} = 1.2 V ± 0.1 V	3	10	
		V_{CCB} = 1.5 V ± 0.1 V	2	7	
		V_{CCB} = 1.8 V ± 0.15 V	2	6	
		V_{CCB} = 2.5 V ± 0.2 V	2	5	
		V_{CCB} = 3.3 V ± 0.3 V	2	4	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	8	53	
		V_{CCB} = 0.8 V ± 0.04 V	6	26	
		V_{CCB} = 0.9 V ± 0.045 V	5	16	
		V_{CCB} = 1.2 V ± 0.1 V	3	8	
		V_{CCB} = 1.5 V ± 0.1 V	3	7	
		V_{CCB} = 1.8 V ± 0.15 V	2	6	
		V_{CCB} = 2.5 V ± 0.2 V	2	5	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	9	13	ns
		V_{CCB} = 0.8 V ± 0.04 V	9	13	
		V_{CCB} = 0.9 V ± 0.045 V	9	13	
		V_{CCB} = 1.2 V ± 0.1 V	9	13	
		V_{CCB} = 1.5 V ± 0.1 V	9	13	
		V_{CCB} = 1.8 V ± 0.15 V	9	13	
		V_{CCB} = 2.5 V ± 0.2 V	9	13	
		V_{CCB} = 3.3 V ± 0.3 V	9	13	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	67	136	
		V_{CCB} = 0.8 V ± 0.04 V	53	96	
		V_{CCB} = 0.9 V ± 0.045 V	45	72	
		V_{CCB} = 1.2 V ± 0.1 V	14	22	
		V_{CCB} = 1.5 V ± 0.1 V	11	15	
		V_{CCB} = 1.8 V ± 0.15 V	10	14	
		V_{CCB} = 2.5 V ± 0.2 V	8	11	
		V_{CCB} = 3.3 V ± 0.3 V	7	11	

Product Folder Links: *SN74AXC1T45*

Switching Characteristics: V_{CCA} = 1.8 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.8 V (see *Figure 6*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		241	ns
		V_{CCB} = 0.8 V ± 0.04 V		176	
		V_{CCB} = 0.9 V ± 0.045 V		148	
		V_{CCB} = 1.2 V ± 0.1 V		35	
		V_{CCB} = 1.5 V ± 0.1 V		28	
		V_{CCB} = 1.8 V ± 0.15 V		26	
		V_{CCB} = 2.5 V ± 0.2 V		21	
		V_{CCB} = 3.3 V ± 0.3 V		24	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		101	
		V_{CCB} = 0.8 V ± 0.04 V		61	
		V_{CCB} = 0.9 V ± 0.045 V		44	
		V_{CCB} = 1.2 V ± 0.1 V		30	
		V_{CCB} = 1.5 V ± 0.1 V		27	
		V_{CCB} = 1.8 V ± 0.15 V		26	
		V_{CCB} = 2.5 V ± 0.2 V		25	
		V_{CCB} = 3.3 V ± 0.3 V		24	

Product Folder Links: *SN74AXC1T45*

6.18 Switching Characteristics: V$_{CCA}$ = 1.8 V, T$_A$ = –40°C to +125°C

over recommended operating free-air temperature range, V$_{CCA}$ = 1.8 V (see *Figure 14*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t$_{pd}$ Propagation delay	A-to-B	V$_{CCB}$ = 0.7 V ± 0.05 V	10	81	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	7	41	
		V$_{CCB}$ = 0.9 V ± 0.045 V	5	24	
		V$_{CCB}$ = 1.2 V ± 0.1 V	3	10	
		V$_{CCB}$ = 1.5 V ± 0.1 V	2	8	
		V$_{CCB}$ = 1.8 V ± 0.15 V	2	7	
		V$_{CCB}$ = 2.5 V ± 0.2 V	2	5	
		V$_{CCB}$ = 3.3 V ± 0.3 V	2	5	
	B-to-A	V$_{CCB}$ = 0.7 V ± 0.05 V	8	53	
		V$_{CCB}$ = 0.8 V ± 0.04 V	6	26	
		V$_{CCB}$ = 0.9 V ± 0.045 V	5	16	
		V$_{CCB}$ = 1.2 V ± 0.1 V	3	9	
		V$_{CCB}$ = 1.5 V ± 0.1 V	3	7	
		V$_{CCB}$ = 1.8 V ± 0.15 V	2	7	
		V$_{CCB}$ = 2.5 V ± 0.2 V	2	5	
		V$_{CCB}$ = 3.3 V ± 0.3 V	1	4	
t$_{dis}$ Disable time	Port A	V$_{CCB}$ = 0.7 V ± 0.05 V	9	18	ns
		V$_{CCB}$ = 0.8 V ± 0.04 V	9	18	
		V$_{CCB}$ = 0.9 V ± 0.045 V	9	18	
		V$_{CCB}$ = 1.2 V ± 0.1 V	9	18	
		V$_{CCB}$ = 1.5 V ± 0.1 V	9	18	
		V$_{CCB}$ = 1.8 V ± 0.15 V	9	18	
		V$_{CCB}$ = 2.5 V ± 0.2 V	9	18	
		V$_{CCB}$ = 3.3 V ± 0.3 V	9	18	
	Port B	V$_{CCB}$ = 0.7 V ± 0.05 V	66	136	
		V$_{CCB}$ = 0.8 V ± 0.04 V	53	96	
		V$_{CCB}$ = 0.9 V ± 0.045 V	45	75	
		V$_{CCB}$ = 1.2 V ± 0.1 V	14	28	
		V$_{CCB}$ = 1.5 V ± 0.1 V	11	20	
		V$_{CCB}$ = 1.8 V ± 0.15 V	10	18	
		V$_{CCB}$ = 2.5 V ± 0.2 V	8	14	
		V$_{CCB}$ = 3.3 V ± 0.3 V	7	13	

Switching Characteristics: V_{CCA} = 1.8 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 1.8 V (see *Figure 14*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		266	ns
		V_{CCB} = 0.8 V ± 0.04 V		184	
		V_{CCB} = 0.9 V ± 0.045 V		155	
		V_{CCB} = 1.2 V ± 0.1 V		42	
		V_{CCB} = 1.5 V ± 0.1 V		33	
		V_{CCB} = 1.8 V ± 0.15 V		32	
		V_{CCB} = 2.5 V ± 0.2 V		24	
		V_{CCB} = 3.3 V ± 0.3 V		26	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		105	
		V_{CCB} = 0.8 V ± 0.04 V		65	
		V_{CCB} = 0.9 V ± 0.045 V		48	
		V_{CCB} = 1.2 V ± 0.1 V		34	
		V_{CCB} = 1.5 V ± 0.1 V		32	
		V_{CCB} = 1.8 V ± 0.15 V		31	
		V_{CCB} = 2.5 V ± 0.2 V		29	
		V_{CCB} = 3.3 V ± 0.3 V		29	

Product Folder Links: *SN74AXC1T45*

6.19 Switching Characteristics: V_{CCA} = 2.5 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 2.5 V (see *Figure 8*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	10	80	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	40	
		V_{CCB} = 0.9 V ± 0.045 V	5	22	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	5	
		V_{CCB} = 1.8 V ± 0.15 V	2	5	
		V_{CCB} = 2.5 V ± 0.2 V	1	4	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	8	66	
		V_{CCB} = 0.8 V ± 0.04 V	5	27	
		V_{CCB} = 0.9 V ± 0.045 V	4	15	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	5	
		V_{CCB} = 1.8 V ± 0.15 V	2	5	
		V_{CCB} = 2.5 V ± 0.2 V	1	4	
		V_{CCB} = 3.3 V ± 0.3 V	1	3	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	7	10	ns
		V_{CCB} = 0.8 V ± 0.04 V	7	10	
		V_{CCB} = 0.9 V ± 0.045 V	7	10	
		V_{CCB} = 1.2 V ± 0.1 V	7	10	
		V_{CCB} = 1.5 V ± 0.1 V	7	10	
		V_{CCB} = 1.8 V ± 0.15 V	7	10	
		V_{CCB} = 2.5 V ± 0.2 V	7	10	
		V_{CCB} = 3.3 V ± 0.3 V	7	10	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	67	136	
		V_{CCB} = 0.8 V ± 0.04 V	53	95	
		V_{CCB} = 0.9 V ± 0.045 V	45	71	
		V_{CCB} = 1.2 V ± 0.1 V	14	21	
		V_{CCB} = 1.5 V ± 0.1 V	11	14	
		V_{CCB} = 1.8 V ± 0.15 V	10	13	
		V_{CCB} = 2.5 V ± 0.2 V	7	10	
		V_{CCB} = 3.3 V ± 0.3 V	6	10	

Submit Documentation Feedback   35

Product Folder Links: *SN74AXC1T45*

Switching Characteristics: V_{CCA} = 2.5 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 2.5 V (see *Figure 8*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		254	ns
		V_{CCB} = 0.8 V ± 0.04 V		176	
		V_{CCB} = 0.9 V ± 0.045 V		147	
		V_{CCB} = 1.2 V ± 0.1 V		33	
		V_{CCB} = 1.5 V ± 0.1 V		25	
		V_{CCB} = 1.8 V ± 0.15 V		24	
		V_{CCB} = 2.5 V ± 0.2 V		19	
		V_{CCB} = 3.3 V ± 0.3 V		22	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		99	
		V_{CCB} = 0.8 V ± 0.04 V		55	
		V_{CCB} = 0.9 V ± 0.045 V		41	
		V_{CCB} = 1.2 V ± 0.1 V		22	
		V_{CCB} = 1.5 V ± 0.1 V		24	
		V_{CCB} = 1.8 V ± 0.15 V		20	
		V_{CCB} = 2.5 V ± 0.2 V		23	
		V_{CCB} = 3.3 V ± 0.3 V		19	

Product Folder Links: *SN74AXC1T45*

6.20 Switching Characteristics: V_{CCA} = 2.5 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 2.5 V (see *Figure 15*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	9	80	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	40	
		V_{CCB} = 0.9 V ± 0.045 V	5	22	
		V_{CCB} = 1.2 V ± 0.1 V	3	8	
		V_{CCB} = 1.5 V ± 0.1 V	2	6	
		V_{CCB} = 1.8 V ± 0.15 V	2	5	
		V_{CCB} = 2.5 V ± 0.2 V	1	5	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	8	66	
		V_{CCB} = 0.8 V ± 0.04 V	5	27	
		V_{CCB} = 0.9 V ± 0.045 V	4	15	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	6	
		V_{CCB} = 1.8 V ± 0.15 V	2	5	
		V_{CCB} = 2.5 V ± 0.2 V	1	5	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
t_{dis} Disable time	Port A disable time	V_{CCB} = 0.7 V ± 0.05 V	7	13	ns
		V_{CCB} = 0.8 V ± 0.04 V	7	13	
		V_{CCB} = 0.9 V ± 0.045 V	7	13	
		V_{CCB} = 1.2 V ± 0.1 V	7	13	
		V_{CCB} = 1.5 V ± 0.1 V	7	13	
		V_{CCB} = 1.8 V ± 0.15 V	7	13	
		V_{CCB} = 2.5 V ± 0.2 V	7	13	
		V_{CCB} = 3.3 V ± 0.3 V	7	13	
	Port B disable time	V_{CCB} = 0.7 V ± 0.05 V	66	136	
		V_{CCB} = 0.8 V ± 0.04 V	53	95	
		V_{CCB} = 0.9 V ± 0.045 V	45	75	
		V_{CCB} = 1.2 V ± 0.1 V	14	27	
		V_{CCB} = 1.5 V ± 0.1 V	11	20	
		V_{CCB} = 1.8 V ± 0.15 V	10	17	
		V_{CCB} = 2.5 V ± 0.2 V	7	13	
		V_{CCB} = 3.3 V ± 0.3 V	6	12	

Switching Characteristics: V_{CCA} = 2.5 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 2.5 V (see *Figure 15*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A enable time	V_{CCB} = 0.7 V ± 0.05 V		278	ns
		V_{CCB} = 0.8 V ± 0.04 V		185	
		V_{CCB} = 0.9 V ± 0.045 V		153	
		V_{CCB} = 1.2 V ± 0.1 V		39	
		V_{CCB} = 1.5 V ± 0.1 V		31	
		V_{CCB} = 1.8 V ± 0.15 V		29	
		V_{CCB} = 2.5 V ± 0.2 V		23	
		V_{CCB} = 3.3 V ± 0.3 V		25	
	Port B enable time	V_{CCB} = 0.7 V ± 0.05 V		98	
		V_{CCB} = 0.8 V ± 0.04 V		58	
		V_{CCB} = 0.9 V ± 0.045 V		40	
		V_{CCB} = 1.2 V ± 0.1 V		26	
		V_{CCB} = 1.5 V ± 0.1 V		24	
		V_{CCB} = 1.8 V ± 0.15 V		23	
		V_{CCB} = 2.5 V ± 0.2 V		23	
		V_{CCB} = 3.3 V ± 0.3 V		22	

Product Folder Links: *SN74AXC1T45*

6.21 Switching Characteristics: V_{CCA} = 3.3 V ± 0.3 V, T_A = –40°C to +85°C

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see *Figure 7*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	9	79	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	39	
		V_{CCB} = 0.9 V ± 0.045 V	5	22	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	4	
		V_{CCB} = 1.8 V ± 0.15 V	2	4	
		V_{CCB} = 2.5 V ± 0.2 V	1	3	
		V_{CCB} = 3.3 V ± 0.3 V	1	3	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	10	144	
		V_{CCB} = 0.8 V ± 0.04 V	6	36	
		V_{CCB} = 0.9 V ± 0.045 V	4	18	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	5	
		V_{CCB} = 1.8 V ± 0.15 V	2	4	
		V_{CCB} = 2.5 V ± 0.2 V	1	4	
		V_{CCB} = 3.3 V ± 0.3 V	1	3	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	6	9	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	9	
		V_{CCB} = 0.9 V ± 0.045 V	6	9	
		V_{CCB} = 1.2 V ± 0.1 V	6	9	
		V_{CCB} = 1.5 V ± 0.1 V	6	9	
		V_{CCB} = 1.8 V ± 0.15 V	6	9	
		V_{CCB} = 2.5 V ± 0.2 V	6	9	
		V_{CCB} = 3.3 V ± 0.3 V	6	9	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	3	136	
		V_{CCB} = 0.8 V ± 0.04 V	3	95	
		V_{CCB} = 0.9 V ± 0.045 V	3	71	
		V_{CCB} = 1.2 V ± 0.1 V	3	21	
		V_{CCB} = 1.5 V ± 0.1 V	3	14	
		V_{CCB} = 1.8 V ± 0.15 V	10	12	
		V_{CCB} = 2.5 V ± 0.2 V	7	10	
		V_{CCB} = 3.3 V ± 0.3 V	6	10	

Switching Characteristics: V_{CCA} = 3.3 V ± 0.3 V, T_A = –40°C to +85°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see *Figure 7*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		331	ns
		V_{CCB} = 0.8 V ± 0.04 V		185	
		V_{CCB} = 0.9 V ± 0.045 V		149	
		V_{CCB} = 1.2 V ± 0.1 V		33	
		V_{CCB} = 1.5 V ± 0.1 V		25	
		V_{CCB} = 1.8 V ± 0.15 V		23	
		V_{CCB} = 2.5 V ± 0.2 V		19	
		V_{CCB} = 3.3 V ± 0.3 V		22	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		98	
		V_{CCB} = 0.8 V ± 0.04 V		58	
		V_{CCB} = 0.9 V ± 0.045 V		41	
		V_{CCB} = 1.2 V ± 0.1 V		26	
		V_{CCB} = 1.5 V ± 0.1 V		23	
		V_{CCB} = 1.8 V ± 0.15 V		23	
		V_{CCB} = 2.5 V ± 0.2 V		22	
		V_{CCB} = 3.3 V ± 0.3 V		22	

Product Folder Links: *SN74AXC1T45*

6.22 Switching Characteristics: V_{CCA} = 3.3 V ± 0.3 V, T_A = –40°C to +125°C

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see *Figure 16*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{pd} Propagation delay	A-to-B	V_{CCB} = 0.7 V ± 0.05 V	9	79	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	39	
		V_{CCB} = 0.9 V ± 0.045 V	4	22	
		V_{CCB} = 1.2 V ± 0.1 V	3	7	
		V_{CCB} = 1.5 V ± 0.1 V	2	5	
		V_{CCB} = 1.8 V ± 0.15 V	2	4	
		V_{CCB} = 2.5 V ± 0.2 V	1	4	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
	B-to-A	V_{CCB} = 0.7 V ± 0.05 V	9	144	
		V_{CCB} = 0.8 V ± 0.04 V	6	36	
		V_{CCB} = 0.9 V ± 0.045 V	4	18	
		V_{CCB} = 1.2 V ± 0.1 V	3	8	
		V_{CCB} = 1.5 V ± 0.1 V	2	6	
		V_{CCB} = 1.8 V ± 0.15 V	2	5	
		V_{CCB} = 2.5 V ± 0.2 V	1	4	
		V_{CCB} = 3.3 V ± 0.3 V	1	4	
t_{dis} Disable time	Port A	V_{CCB} = 0.7 V ± 0.05 V	6	12	ns
		V_{CCB} = 0.8 V ± 0.04 V	6	12	
		V_{CCB} = 0.9 V ± 0.045 V	6	12	
		V_{CCB} = 1.2 V ± 0.1 V	6	12	
		V_{CCB} = 1.5 V ± 0.1 V	6	12	
		V_{CCB} = 1.8 V ± 0.15 V	6	12	
		V_{CCB} = 2.5 V ± 0.2 V	6	12	
		V_{CCB} = 3.3 V ± 0.3 V	6	12	
	Port B	V_{CCB} = 0.7 V ± 0.05 V	3	136	
		V_{CCB} = 0.8 V ± 0.04 V	3	95	
		V_{CCB} = 0.9 V ± 0.045 V	3	75	
		V_{CCB} = 1.2 V ± 0.1 V	3	27	
		V_{CCB} = 1.5 V ± 0.1 V	3	19	
		V_{CCB} = 1.8 V ± 0.15 V	10	17	
		V_{CCB} = 2.5 V ± 0.2 V	7	13	
		V_{CCB} = 3.3 V ± 0.3 V	6	12	

Switching Characteristics: V_{CCA} = 3.3 V ± 0.3 V, T_A = –40°C to +125°C (continued)

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see *Figure 16*)

PARAMETER		TEST CONDITIONS	MIN	MAX	UNIT
t_{en} Enable time	Port A	V_{CCB} = 0.7 V ± 0.05 V		356	ns
		V_{CCB} = 0.8 V ± 0.04 V		93	
		V_{CCB} = 0.9 V ± 0.045 V		156	
		V_{CCB} = 1.2 V ± 0.1 V		40	
		V_{CCB} = 1.5 V ± 0.1 V		31	
		V_{CCB} = 1.8 V ± 0.15 V		29	
		V_{CCB} = 2.5 V ± 0.2 V		22	
		V_{CCB} = 3.3 V ± 0.3 V		24	
	Port B	V_{CCB} = 0.7 V ± 0.05 V		99	
		V_{CCB} = 0.8 V ± 0.04 V		59	
		V_{CCB} = 0.9 V ± 0.045 V		42	
		V_{CCB} = 1.2 V ± 0.1 V		27	
		V_{CCB} = 1.5 V ± 0.1 V		25	
		V_{CCB} = 1.8 V ± 0.15 V		24	
		V_{CCB} = 2.5 V ± 0.2 V		24	
		V_{CCB} = 3.3 V ± 0.3 V		24	

Product Folder Links: *SN74AXC1T45*

6.23 Operating Characteristics

$T_A = 25°C$

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
C_{pdA}	Power dissipation capacitance per transceiver	$C_L = 0$ pF, $f = 1$ MHz, $t_r = t_f = 1$ ns	A-port input, B-port output				pF
			$V_{CCA} = V_{CCB} = 0.7$ V		1.3		
			$V_{CCA} = V_{CCB} = 0.8$ V		1.3		
			$V_{CCA} = V_{CCB} = 0.9$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.2$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.5$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.8$ V		1.4		
			$V_{CCA} = V_{CCB} = 2.5$ V		1.7		
			$V_{CCA} = V_{CCB} = 3.3$ V		2.1		
			B-port input, A-port output				
			$V_{CCA} = V_{CCB} = 0.7$ V		9.2		
			$V_{CCA} = V_{CCB} = 0.8$ V		9.4		
			$V_{CCA} = V_{CCB} = 0.9$ V		9.4		
			$V_{CCA} = V_{CCB} = 1.2$ V		9.8		
			$V_{CCA} = V_{CCB} = 1.5$ V		10.1		
			$V_{CCA} = V_{CCB} = 1.8$ V		11.0		
			$V_{CCA} = V_{CCB} = 2.5$ V		14.4		
			$V_{CCA} = V_{CCB} = 3.3$ V		18.6		
C_{pdB}	Power dissipation capacitance per transceiver	$C_L = 0$ pF, $f = 1$ MHz, $t_r = t_f = 1$ ns	A-port input, B-port output				pF
			$V_{CCA} = V_{CCB} = 0.7$ V		9.2		
			$V_{CCA} = V_{CCB} = 0.8$ V		9.3		
			$V_{CCA} = V_{CCB} = 0.9$ V		9.4		
			$V_{CCA} = V_{CCB} = 1.2$ V		9.7		
			$V_{CCA} = V_{CCB} = 1.5$ V		10.1		
			$V_{CCA} = V_{CCB} = 1.8$ V		11.0		
			$V_{CCA} = V_{CCB} = 2.5$ V		14.4		
			$V_{CCA} = V_{CCB} = 3.3$ V		18.3		
			B-port input, A-port output				
			$V_{CCA} = V_{CCB} = 0.7$ V		1.3		
			$V_{CCA} = V_{CCB} = 0.8$ V		1.3		
			$V_{CCA} = V_{CCB} = 0.9$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.2$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.5$ V		1.3		
			$V_{CCA} = V_{CCB} = 1.8$ V		1.4		
			$V_{CCA} = V_{CCB} = 2.5$ V		1.7		
			$V_{CCA} = V_{CCB} = 3.3$ V		2.1		

6.24 Typical Characteristics

$T_A = 25°C$ $V_{CCA} = 0.7$ V

Figure 1. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 0.8$ V

Figure 2. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 0.9$ V

Figure 3. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 1.2$ V

Figure 4. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 1.5$ V

Figure 5. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 1.8$ V

Figure 6. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 3.3$ V

Figure 7. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

$T_A = 25°C$ $V_{CCA} = 2.5$ V

Figure 8. Typical Propagation Delay of Low-to-High (A to B) vs Load Capacitance

Product Folder Links: *SN74AXC1T45*

Typical Characteristics (continued)

$T_A = 25°C \quad V_{CCA} = 0.7 \text{ V}$

Figure 9. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 0.8 \text{ V}$

Figure 10. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 0.9 \text{ V}$

Figure 11. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 1.2 \text{ V}$

Figure 12. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 1.5 \text{ V}$

Figure 13. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 1.8 \text{ V}$

Figure 14. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance

$T_A = 25°C \quad V_{CCA} = 2.5 \text{ V}$

Figure 15. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance
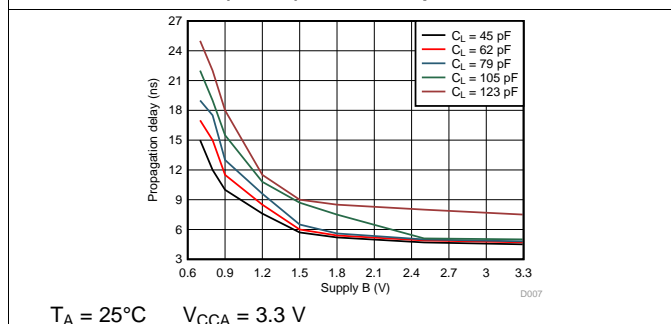

$T_A = 25°C \quad V_{CCA} = 3.3 \text{ V}$

Figure 16. Typical Propagation Delay of Low-to-High (B to A) vs Load Capacitance
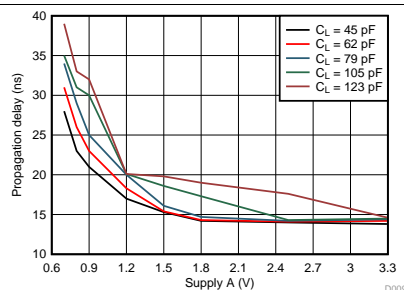
Product Folder Links: *SN74AXC1T45*

7 Parameter Measurement Information

7.1 Load Circuit and Voltage Waveforms

Unless otherwise noted, all input pulses are supplied by generators having the following characteristics: f = 1 MHz, Z_O = 50 Ω, dv/dt ≤ 1 ns/V

(1) C_L includes probe and jig capacitance.

Figure 17. Load Circuit

Table 1. Load Circuit Conditions

Parameter		V_{CCO}	R_L	C_L	S_1	V_{TP}
Δt/Δv	Input transition rise or fall rate	0.65 V – 3.6 V	1 MΩ	15 pF	Open	N/A
t_{pd}	Propagation (delay) time	1.1 V – 3.6 V	2 kΩ	15 pF	Open	N/A
		0.65 V – 0.95 V	20 kΩ	15 pF	Open	N/A
t_{en}, t_{dis}	Enable time, disable time	3 V – 3.6 V	2 kΩ	15 pF	2 × V_{CCO}	0.3 V
		1.65 V – 2.7 V	2 kΩ	15 pF	2 × V_{CCO}	0.15 V
		1.1 V – 1.6 V	2 kΩ	15 pF	2 × V_{CCO}	0.1 V
		0.65 V – 0.95 V	20 kΩ	15 pF	2 × V_{CCO}	0.1 V
t_{en}, t_{dis}	Enable time, disable time	3 V – 3.6 V	2 kΩ	15 pF	GND	0.3 V
		1.65 V – 2.7 V	2 kΩ	15 pF	GND	0.15 V
		1.1 V – 1.6 V	2 kΩ	15 pF	GND	0.1 V
		0.65 V – 0.95 V	20 kΩ	15 pF	GND	0.1 V

1. V_{CCI} is the supply pin associated with the input port.
2. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L, C_L, and S_1

Figure 18. Propagation Delay

1. V_{CCI} is the supply pin associated with the input port.
2. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L, C_L, and S_1

Figure 19. Input Transition Rise or Fall Rate

Copyright © 2017, Texas Instruments Incorporated

1. Illustrative purposes only. Enable Time is a calculation as described in the data sheet.
2. Output waveform on the condition that input is driven to a valid Logic Low.
3. Output waveform on the condition that input is driven to a valid Logic High.
4. V_{CCI} is the supply pin associated with the input port
5. V_{CCO} is the supply pin associated with the output port.
6. V_{OH} and V_{OL} are typical output voltage levels that occur with specified R_L, C_L, and S_1

Figure 20. Disable and Enable Time

Product Folder Links: *SN74AXC1T45*

8 Detailed Description

8.1 Overview

The SN74AXC1T45 is single-bit, dual-supply, noninverting voltage level translation. Pin A and the direction control pin are support by V_{CCA} and pin B is support by V_{CCB}. The A port can accept I/O voltages ranging from 0.65 V to 3.6 V, and the B port can accept I/O voltages from 0.65 V to 3.6 V. A high logic on the DIR pin allows data transmission from A to B and a logic low on the DIR pin allows data transmission from B to A.

8.2 Functional Block Diagram

Copyright © 2017, Texas Instruments Incorporated

8.3 Feature Description

8.3.1 Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 0.65-V to 3.6-V Power-Supply Range

Both the V_{CCA} and V_{CCB} pins can be supplied at any voltage from 0.65 V to 3.6 V, making the device suitable for translating between any of the voltage nodes (0.7 V, 0.8 V, 0.9 V, 1.2 V, 1.8 V, 2.5 V and 3.3 V).

8.3.2 Support High-Speed Translation

The SN74AXC1T45 device can support high data-rate applications. The translated signal data rate can be up to 500 Mbps when signal is translated from 1.8 V to 3.3 V.

8.3.3 I_{off} Supports Partial-Power-Down Mode Operation

The I_{off} circuit prevents backflow current by disabling the I/O output circuits when the device is in partial-power-down mode.

8.4 Device Functional Modes

Table 2 lists the device functions for the DIR input.

Table 2. Function Table

INPUT[1] DIR	OPERATION
L	B data to A bus
H	A data to B bus

(1) Input circuits of the data I/Os always are active.

9 Application and Implementation

> **NOTE**
>
> Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The SN74AXC1T45 device can be used in level-translation applications for interfacing devices or systems with one another when they are operating at different interface voltages. The maximum data rate can be up to 500 Mbps when the device translate signal is from 1.8 V to 3.3 V.

9.1.1 Enable Times

Calculate the enable times for the SN74AXC1T45 using the following formulas:

t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)   (1)

t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)   (2)

t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)   (3)

t_{PZL} (DIR to B) = t_{PHZ} (DIR to A) + t_{PHL} (A to B)   (4)

In a bidirectional application, these enable times provide the maximum delay time from the time the DIR bit is switched until an output is expected. For example, if the SN74AXC1T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.

9.2 Typical Applications

9.2.1 Unidirectional Logic Level-Shifting Application

Figure 21 shows an example of the SN74AXC1T45 being used in a unidirectional logic level-shifting application.

Figure 21. Unidirectional Logic Level-Shifting Application

Table 3. Unidirectional Level Shifting Function

PIN	NAME	FUNCTION	DESCRIPTION
1	V_{CCA}	V_{CC1}	SYSTEM-1 supply voltage (0.65 V to 3.6 V)
2	GND	GND	Device GND
3	A	OUT	Output level depends on V_{CC1} voltage.
4	B	IN	Input threshold value depends on V_{CC2} voltage.
5	DIR	DIR	GND (low level) determines B-port to A-port direction.
6	V_{CCB}	V_{CC2}	SYSTEM-2 supply voltage (0.65 V to 3.6 V)

9.2.1.1 Design Requirements

For this design example, use the parameters listed in Table 4.

Table 4. Design Parameters

DESIGN PARAMETERS	EXAMPLE VALUES
Input voltage range	0.65 V to 3.6 V
Output voltage range	0.65 V to 3.6 V

Product Folder Links: *SN74AXC1T45*

9.2.1.2 Detailed Design Procedure

To begin the design process, determine the following:

- Input voltage range
  - Use the supply voltage of the device that is driving the SN74AXC1T45 device to determine the input voltage range. For a valid logic-high, the value must exceed the high-level input voltage (V_{IH}) of the input port. For a valid logic low the value must be less than the low-level input voltage (V_{IL}) of the input port.
- Output voltage range
  - Use the supply voltage of the device that the SN74AXC1T45 device is driving to determine the output voltage range.

9.2.1.3 Application Curve

Figure 22. Translation Up (1.2 V to 3.3 V) at 2.5 MHz

9.2.2 Bidirectional Logic Level-Shifting Application

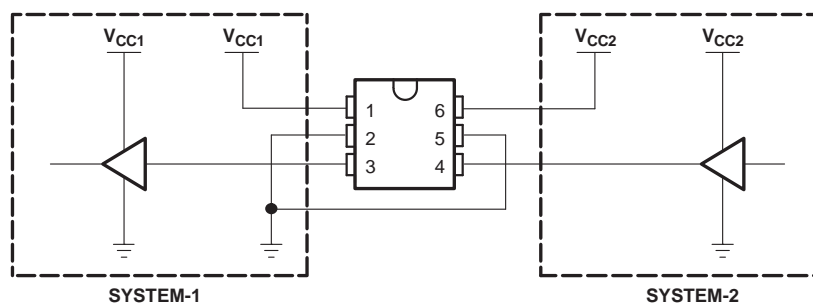Figure 23 shows the SN74AXC1T45 being used in a bidirectional logic level-shifting application. Because the SN74AXC1T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.

Figure 23. Bidirectional Logic Level-Shifting Application

Table 5 lists the data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

Table 5. Data Transmission: SYSTEM-1 and SYSTEM-2

STATE	DIR CTRL	I/O-1	I/O-2	DESCRIPTION
1	H	Out	In	SYSTEM-1 data to SYSTEM-2
2	H	Hi-Z	Hi-Z	SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown resistors. [1]
3	L	Hi-Z	Hi-Z	DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown resistors. [1]
4	L	In	Out	SYSTEM-2 data to SYSTEM-1

(1)   SYSTEM-1 and SYSTEM-2 must use the same conditions, essentially, both pullup or both pulldown.

9.2.2.1 Design Requirements

Refer to *Design Requirements*.

9.2.2.2 Detailed Design Procedure

Refer to *Detailed Design Procedure*.

9.2.2.3 Application Curve

Figure 24. Translation Up (1.2 V to 3.3 V) at 2.5 MHz

10 Power Supply Recommendations

The SN74AXC1T45 device uses two separate configurable power-supply rails, V_{CCA} and V_{CCB}. The V_{CCA} power-supply rail accepts any supply voltage from 0.65 V to 3.6 V and the V_{CCB} power-supply rail accepts any supply voltage from 0.65 V to 3.6 V. The A port and B port are designed to track the V_{CCA} and V_{CCB} supplies respectively allowing for low-voltage, bidirectional translation between any of the 0.7-V, 0.8-V, 0.9-V, 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

10.1 Power-Up Considerations

A proper power-up sequence must be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

1. Connect the ground before any supply voltage is applied.
2. Power up the V_{CCA} and V_{CCB} supplies. The V_{CCA} and V_{CCB} supplies can be ramped in any order.

11 Layout

11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended:
* Bypass capacitors should be used on power supplies.
* Short trace lengths should be used to avoid excessive loading.
* Placing pads on the signal paths for loading capacitors or pullup resistors to help adjust rise and fall times of signals depending on the system requirements.

11.2 Layout Example

Figure 25. PCB Layout Example

Copyright © 2017, Texas Instruments Incorporated

Product Folder Links: *SN74AXC1T45*

12 Device and Documentation Support

12.1 Documentation Support

12.1.1 Related Documentation

For related documentation see the following:
- Texas Instruments, *Evaluate SN74AXC1T45DRL Using a Generic EVM* application report
- Texas Instruments, *Implications of Slow or Floating CMOS Inputs* application report
- Texas Instruments, *Power Sequencing for the AXC Family of Devices* application report

12.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

12.4 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

12.5 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.6 Glossary

SLYZ022 — *TI Glossary*.
   This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

TEXAS INSTRUMENTS

www.ti.com

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74AXC1T45DBVR	ACTIVE	SOT-23	DBV	6	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	1GRL	Samples
SN74AXC1T45DCKR	ACTIVE	SC70	DCK	6	3000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 125	1A3	Samples
SN74AXC1T45DRLR	ACTIVE	SOT-5X3	DRL	6	4000	Green (RoHS & no Sb/Br)	CU NIPDAUAG	Level-1-260C-UNLIM	-40 to 125	1A1	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74AXC1T45DBVR	SOT-23	DBV	6	3000	180.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
SN74AXC1T45DCKR	SC70	DCK	6	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
SN74AXC1T45DRLR	SOT-5X3	DRL	6	4000	180.0	8.4	1.98	1.78	0.69	4.0	8.0	Q3

A

$\frac{1,70}{1,50}$

$6X \frac{0,27}{0,13}$

C

B

6   5   4

C $\frac{1,30}{1,10}$

$\frac{1,70}{1,50}$

Pin 1 Index Area

1   2   3

0,50 $6X \frac{0,25}{0,15}$

| ⊕ | 0,10 Ⓜ | C | A | B |
| | 0,05 Ⓜ | C | | |

$\frac{0,60}{0,50}$

⌒ | 0,05 | C

Seating Plane

$\frac{0,05}{0,00}$ C

$\frac{0,18}{0,08}$

1   2   3

$6X \frac{0,40}{0,20}$

6   5   4

Bottom View

4205622−3/D   08/2007

NOTES: A.   All linear dimensions are in millimeters.   Dimensioning and tolerancing per ASME Y14.5M−1994.
         B.   This drawing is subject to change without notice.
       C   Body dimensions do not include mold flash, interlead flash, protrusions, or gate burrs.
            Mold flash, interlead flash, protrusions, or gate burrs shall not exceed 0,15 per end or side.
         D.   JEDEC package registration is pending.

DRL (R−PDSO−N6)   PLASTIC SMALL OUTLINE

Example Board Layout

Example Stencil Design
(Note E)

1,00

0,45

1,80   0,90

0,30

0,50

Example
Non−Soldermask Defined Pad

Example
Pad Geometry

Example
Non−Soldermask Opening

0,05
All Around

1,00

0,55

1,90   0,80

0,40

0,50

4208207−3/E 06/12

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
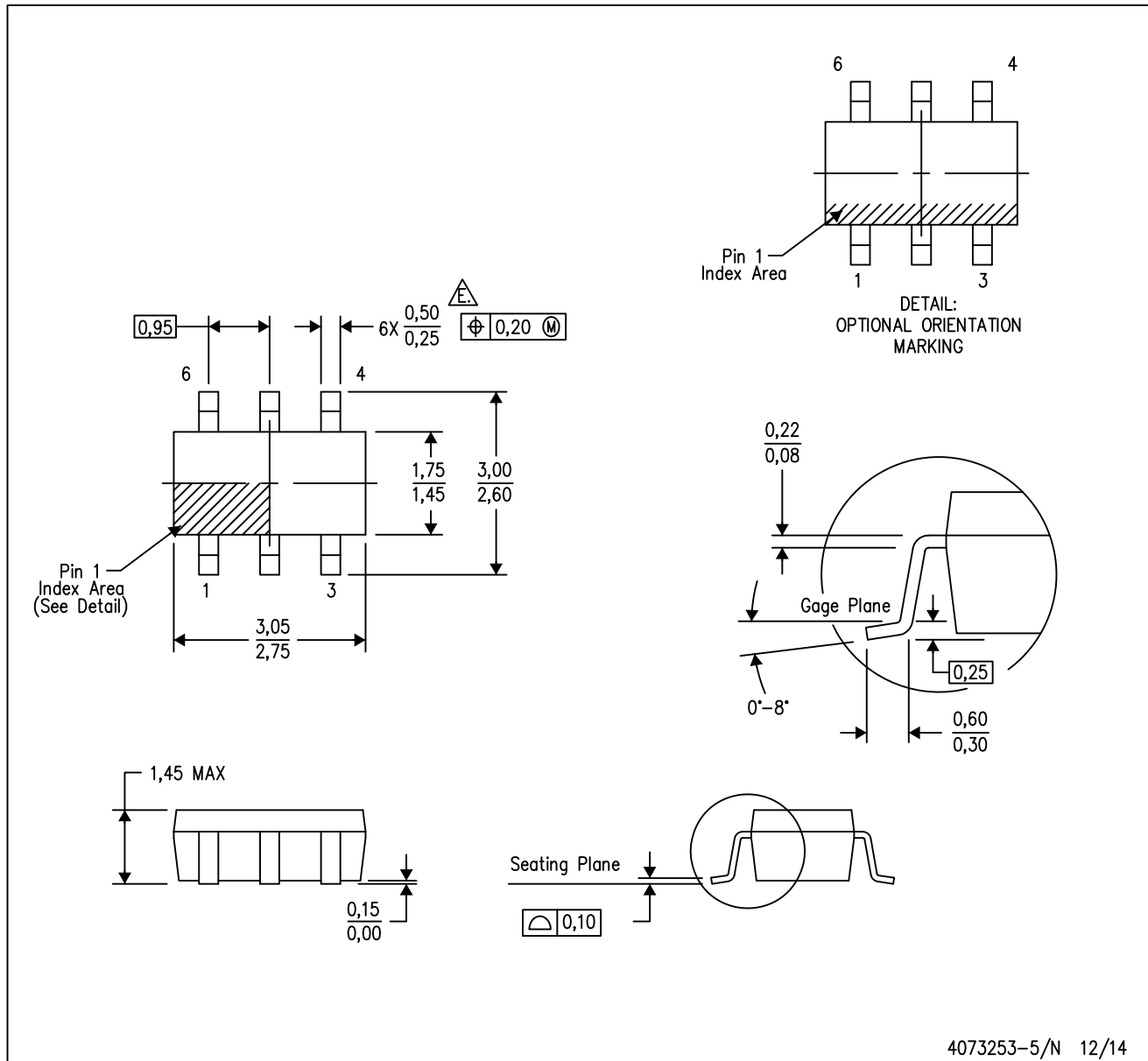   C. Publication IPC−7351 is recommended for alternate designs.
        D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
        E. Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
        F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should
            contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
        G. Side aperture dimensions over−print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions
            if stencil manufacturing process allows for sufficient release at smaller opening.

DBV (R−PDSO−G6)   PLASTIC SMALL−OUTLINE PACKAGE

4073253−5/N   12/14

NOTES: A.   All linear dimensions are in millimeters.
         B.   This drawing is subject to change without notice.
         C.   Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
         D.   Leads 1,2,3 may be wider than leads 4,5,6 for package orientation.
         E.   Falls within JEDEC MO−178 Variation AB, except minimum lead width.

DBV (R-PDSO-G6)   PLASTIC SMALL OUTLINE

Example Board Layout

Stencil Openings
Based on a stencil thickness
of .127mm (.005inch).

1,00

0,55

2,7

2,7

0,95

0,95

0,6

Solder Mask Opening

1,05

Pad Geometry

0,07
All Around

4209593-4/C 08/11

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
        D. Publication IPC-7351 is recommended for alternate designs.
        E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should
            contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric
            metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

DCK (R−PDSO−G6)   PLASTIC SMALL−OUTLINE PACKAGE

2,15 / 1,85

6   4

1,40 / 1,10

2,40 / 1,80

Pin 1
Index Area   1   3

0,65

6X 0,30 / 0,15

⊕ 0,10 Ⓜ

1,30

0,22 / 0,08

Gauge Plane
Seating Plane

0,15   0°−8°

0,46 / 0,26

1,10 / 0,80

0,10

Seating Plane

0,10 / 0,00

4093553−4/G 01/2007

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
        D. Falls within JEDEC MO−203 variation AB.

IMPORTANT NOTICE

Texas Instruments Incorporated (TI) reserves the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete.

TI's published terms of sale for semiconductor products (http://www.ti.com/sc/docs/stdterms.htm) apply to the sale of packaged integrated circuit products that TI has qualified and released to market. Additional terms may apply to the use or sale of other types of TI products and services.

Reproduction of significant portions of TI information in TI data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such reproduced documentation. Information of third parties may be subject to additional restrictions. Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyers and others who are developing systems that incorporate TI products (collectively, "Designers") understand and agree that Designers remain responsible for using their independent analysis, evaluation and judgment in designing their applications and that Designers have full and exclusive responsibility to assure the safety of Designers' applications and compliance of their applications (and of all TI products used in or for Designers' applications) with all applicable regulations, laws and other applicable requirements. Designer represents that, with respect to their applications, Designer has all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. Designer agrees that prior to using or distributing any applications that include TI products, Designer will thoroughly test such applications and the functionality of such TI products as used in such applications.

TI's provision of technical, application or other design advice, quality characterization, reliability data or other services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using TI Resources in any way, Designer (individually or, if Designer is acting on behalf of a company, Designer's company) agrees to use any particular TI Resource solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

Designer is authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS. TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY DESIGNER AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

Unless TI has explicitly designated an individual product as meeting the requirements of a particular industry standard (e.g., ISO/TS 16949 and ISO 26262), TI is not responsible for any failure to meet such industry standard requirements.

Where TI specifically promotes products as facilitating functional safety or as compliant with industry functional safety standards, such products are intended to help enable customers to design and create their own applications that meet applicable functional safety standards and requirements. Using products in an application does not by itself establish any safety features in the application. Designers must ensure compliance with safety-related requirements and standards applicable to their applications. Designer may not use any TI products in life-critical medical equipment unless authorized officers of the parties have executed a special contract specifically governing such use. Life-critical medical equipment is medical equipment where failure of such equipment would cause serious bodily injury or death (e.g., life support, pacemakers, defibrillators, heart pumps, neurostimulators, and implantables). Such equipment includes, without limitation, all medical devices identified by the U.S. Food and Drug Administration as Class III devices and equivalent classifications outside the U.S.

TI may expressly designate certain products as completing a particular qualification (e.g., Q100, Military Grade, or Enhanced Product). Designers agree that it has the necessary expertise to select the product with the appropriate qualification designation for their applications and that proper product selection is at Designers' own risk. Designers are solely responsible for compliance with all legal and regulatory requirements in connection with such selection.

Designer will fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of Designer's non-compliance with the terms and provisions of this Notice.